# **DSC7Q01**

### Silicon NPN epitaxial planar type darlington

For low frequency amplification Darlington connection

#### ■ Features

- High forward current transfer ratio h<sub>FE</sub> with excellent linearity
- $\bullet$  Low collector-emitter saturation voltage  $V_{\text{CE(sat)}}$
- Halogen-free / RoHS compliant
   (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

#### ■ Marking Symbol: 5K

#### ■ Packaging

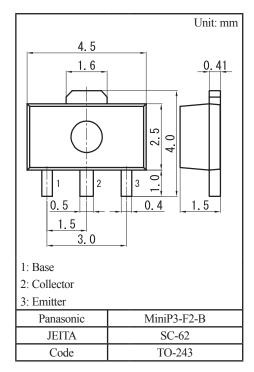
DSC7Q01×0L Embossed type (Thermo-compression sealing): 1 000 pcs / reel (standard)

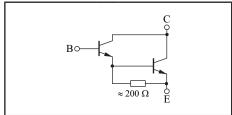
#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	100	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	80	V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V
Collector current	$I_{C}$	1	Α
Peak collector current	$I_{CP}$	1.5	A
Collector power dissipation *1	P <sub>C</sub>	1	W
Junction temperature	T <sub>j</sub>	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*1: Printed circuit board: Copper foil area of 1  $\rm cm^2$  or more, and the board thickness of 1.7 mm for the collector portion

Absolute maximum rating without heat sink for  $P_C$  is  $\ 0.5 \ W$ 





### ■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 100 \mu A, I_E = 0$	100			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	80			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 100  \mu A, I_C = 0$	5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 25 \text{ V}, I_{E} = 0$			0.1	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = 4 \text{ V}, I_C = 0$			0.1	μΑ
Forward current transfer ratio *1,2	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ A}$	4000		40 000	_
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_C = 1 \text{ A}, I_B = 1 \text{ mA}$			1.8	V
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_{\rm C} = 1  \text{A}, I_{\rm B} = 1  \text{mA}$			2.2	V

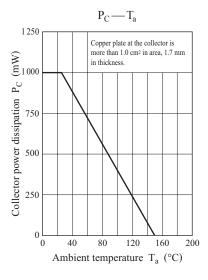
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

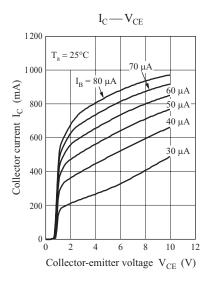
- 2. \*1: Pulse measurement
  - \*2: Rank classification

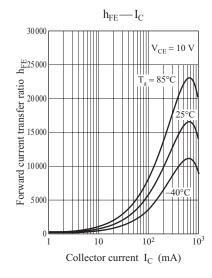
Code	Q	R	S	0
Rank	Q	R	S	No-rank
$h_{\mathrm{FE}}$	4000 to 10000	8000 to 20000	16000 to 40000	4 000 to 40 000
Marking Symbol	5KQ	5KR	5KS	5K

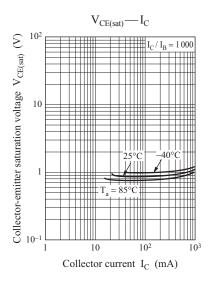
Product of no-rank is not classified and have no marking symbol for rank.

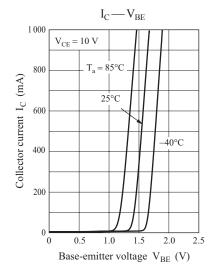
Panasonic DSC7Q01

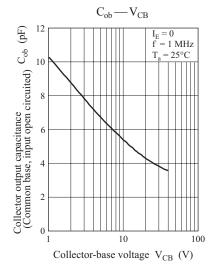


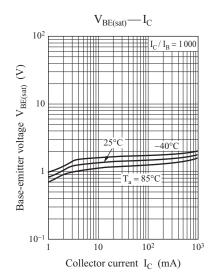








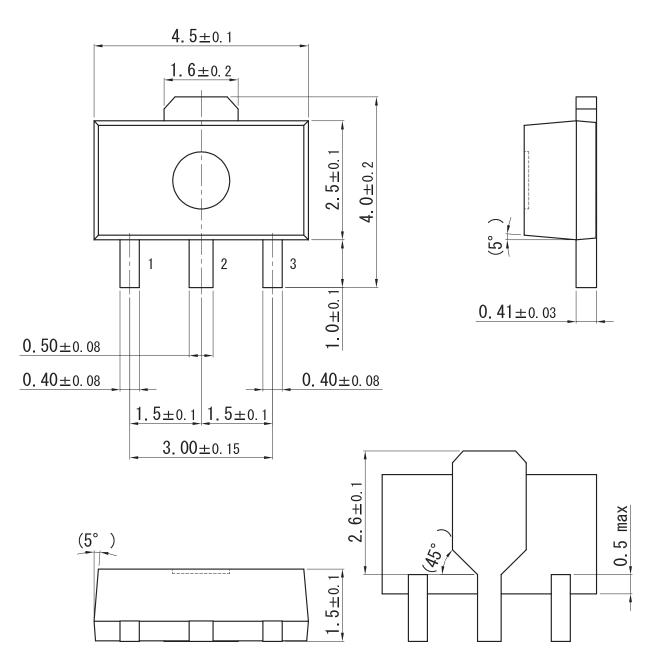




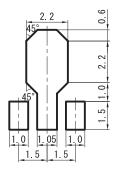
Ver. DED 2

MiniP3-F2-B

Unit: mm



### ■ Land Pattern (Reference) (Unit: mm)



Ver. DED 3

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